OSRAM KRBTQDLP61.3A

Datasheet

Discontinued

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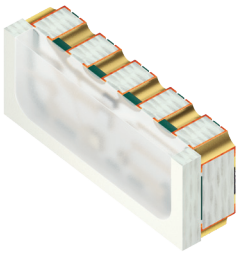
OSRAM

Micro SIDELED™ M4518

KRBT QDLP61.3A - Reverse Mount



To fulfill the needs for pachinko- and gaming applications, this product is especially designed to achieve easy white binning and to reach high ESD level.

Applications

- Access control & security
- Factory automation
- Home & building automation
- Material processing
- Projection & display
- Robotics

Features

- Chip technology: Thinfilm / UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 621 nm (● red); λ_{dom} = 464 nm (● blue); λ_{dom} = 530 nm (● true green)
- Corrosion Robustness Class: 1B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Color: x = 0.245, y = 0.23 acc. to CIE 1931 (white)
- Typ. Luminous Intensity: 2.450 mcd (white), 700 mcd (red), 350 mcd (blue), 1.400 mcd (true green)

Discontinued

Ordering Information

Type	Mounting Methode	Ordering Code
KRBTQDLP61.3A-5B5C-CH-F	Reverse	Q65112A7228

Maximum Ratings

Parameter	Symbol		Values ● red	Values ● blue	Values ● true green
Operating Temperature	T_{op}	min. max.	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C
Junction Temperature	T_j	max.	115 °C	115 °C	115 °C
Forward Current T_S = 25 °C	I_F	max.	30 mA	30 mA	30 mA
Surge Current t ≤ 10 µs; D = 0.005 ; T_S = 25 °C	I_{FS}	max.	100 mA	100 mA	100 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV	8 kV	8 kV
Reverse voltage [1)]	V_R		Not designed for reverse operation	Not designed for reverse operation	Not designed for reverse operation

Discontinued

Characteristics

I_F(● red) = 20 mA; I_F(● blue) = ; I_F(● true green) = ; T_S = 25 °C

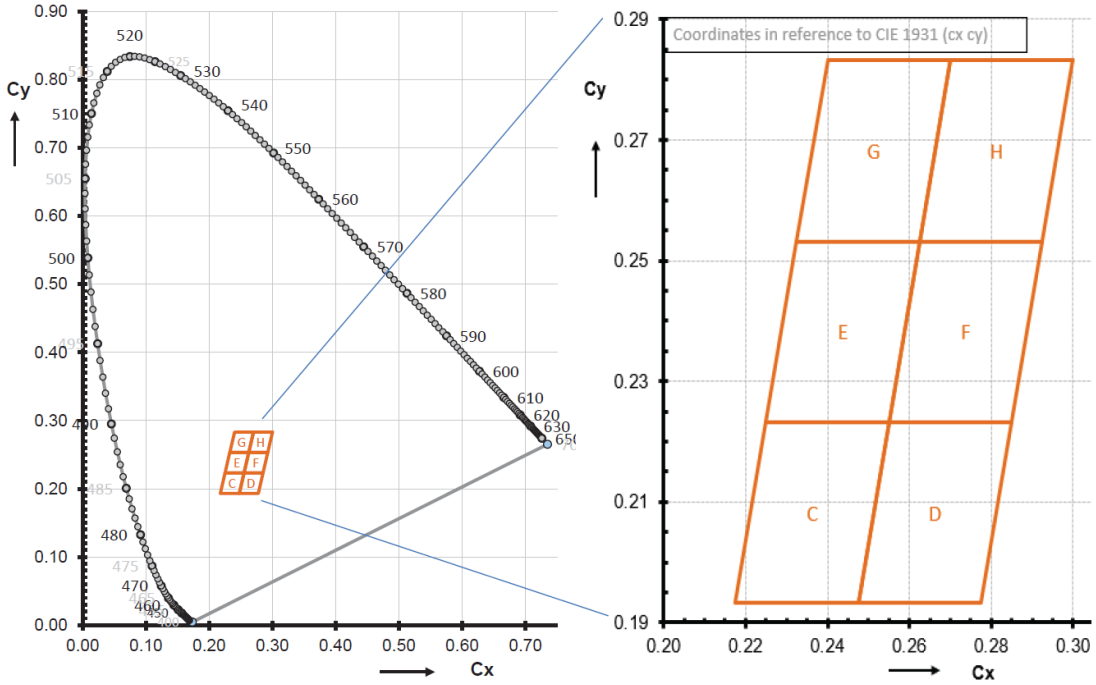
Parameter	Symbol		Values ● red	Values ● blue	Values ● true green
Dominant Wavelength [2]	λ_{dom}	typ.	621 nm	464 nm	530 nm
Spectral bandwidth at 50% $I_{rel,max}$	$\Delta\lambda$	typ.	18 nm	25 nm	33 nm
Viewing angle at 50% I_V	2φ	typ.	120 °	120 °	120 °
Forward Voltage [3] I_F = 20 mA	V_F	typ.	2.1 V	2.9 V	3.2 V
Reverse current [1]	I_R		Not designed for reverse operation	Not designed for reverse operation	Not designed for reverse operation
Real thermal resistance junction/solderpoint [4]	$R_{thJS\ real}$	typ. max.	490 K / W 590 K / W	200 K / W 240 K / W	290 K / W 350 K / W

Discontinued

Brightness Groups

Group	Luminous Intensity [5] I_F = 20 mA min. I_v	Luminous Intensity [5] I_F = 20 mA max. I_v
5B	1800 mcd	2010 mcd
6B	2010 mcd	2240 mcd
7B	2240 mcd	2500 mcd
8B	2500 mcd	2800 mcd
5C	2800 mcd	3150 mcd

Chromaticity Coordinate Groups



Chromaticity Coordinate Groups

Group	Cx	Cy
C	0.2250	0.2232
	0.2175	0.1932
	0.2475	0.1932
	0.2550	0.2232
D	0.2550	0.2232
	0.2850	0.2232
	0.2775	0.1932
	0.2475	0.1932

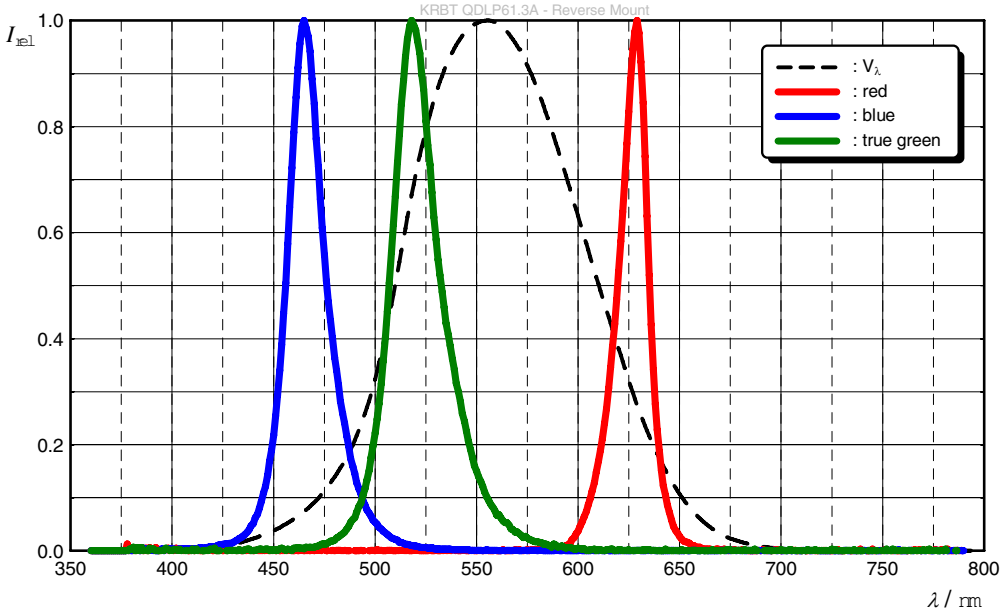
Group	Cx	Cy
E	0.2325	0.2532
	0.2250	0.2232
	0.2550	0.2232
	0.2625	0.2532
F	0.2625	0.2532
	0.2550	0.2232
	0.2850	0.2232
	0.2925	0.2532

Group	Cx	Cy
G	0.2400	0.2832
	0.2325	0.2532
	0.2625	0.2532
	0.2700	0.2832
H	0.2700	0.2832
	0.2625	0.2532
	0.2925	0.2532
	0.3000	0.2832

Discontinued

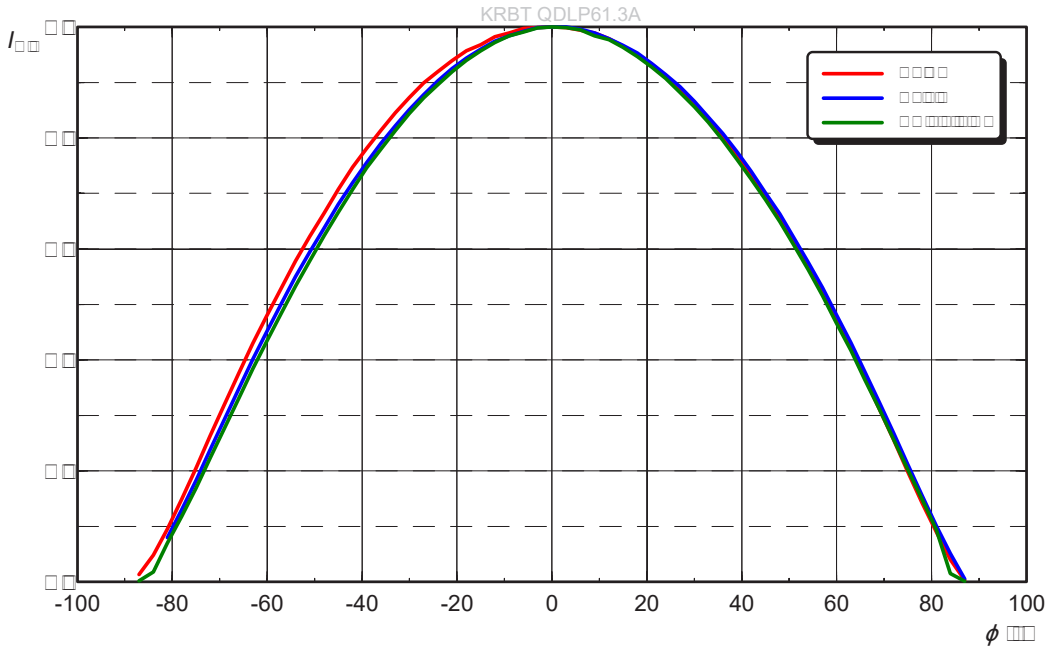
Relative Spectral Emission [6)]

$I_{rel} = f(\lambda)$; I_F = 20 mA; T_S = 25 °C



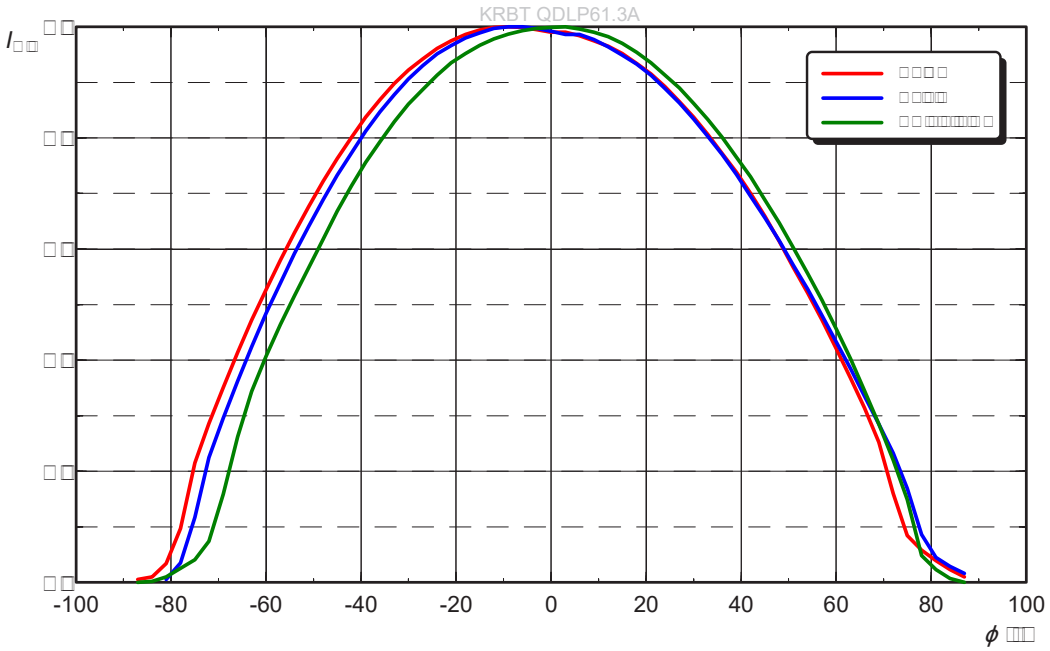
Radiation Characteristic (horizontal) 6)

$I_{rel} = f(\varphi)$; $T_S = 25$ °C



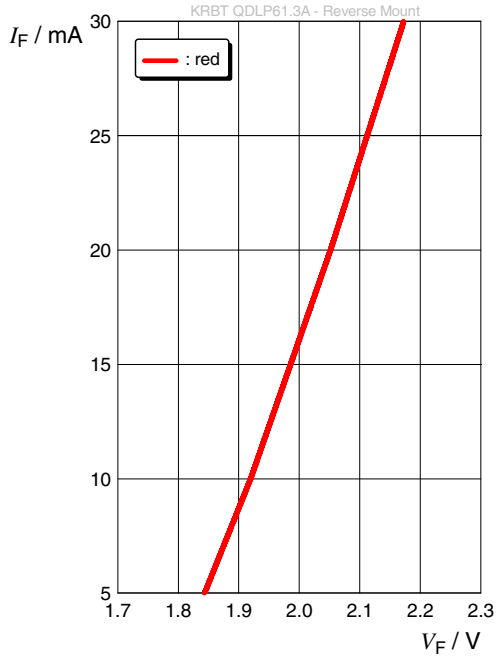
Radiation Characteristic (vertical) 6)

$I_{rel} = f(\varphi)$; $T_S = 25$ °C



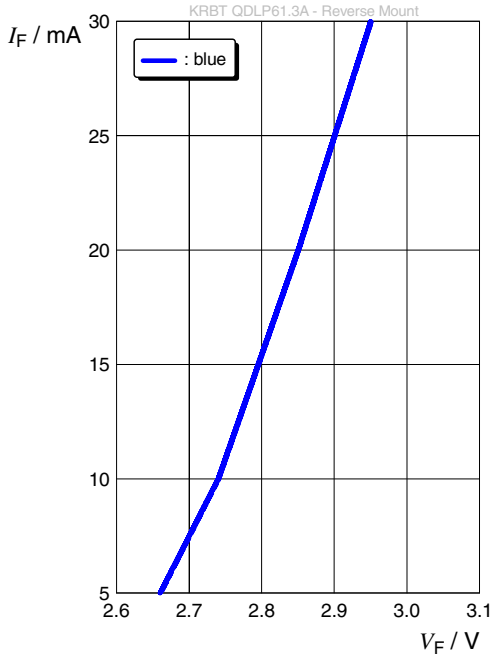
Forward current [6)]

$I_F = f(V_F)$; $T_S = 25$ °C



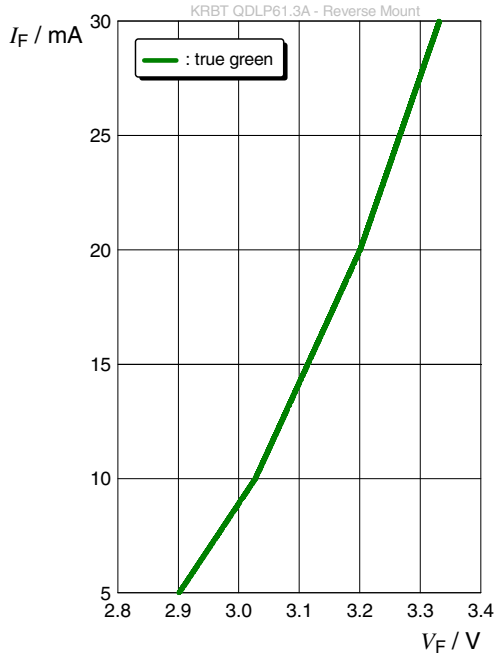
Forward current [6)]

$I_F = f(V_F)$; $T_S = 25$ °C



Forward current [6)]

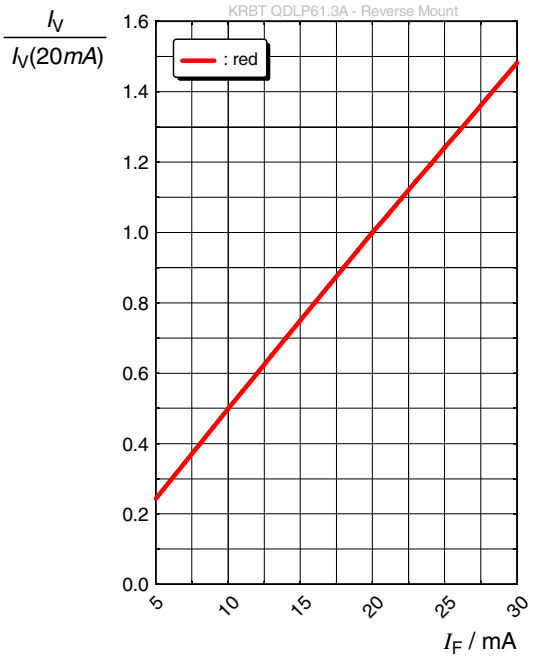
$I_F = f(V_F)$; $T_S = 25$ °C



Discontinued

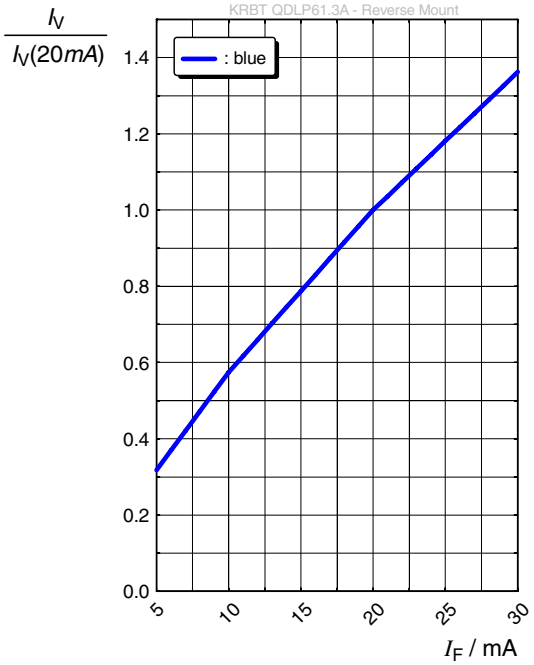
Relative Luminous Intensity 6), 7)

$I_v/I_v(20\ mA) = f(I_F)$; $T_S = 25\ °C$



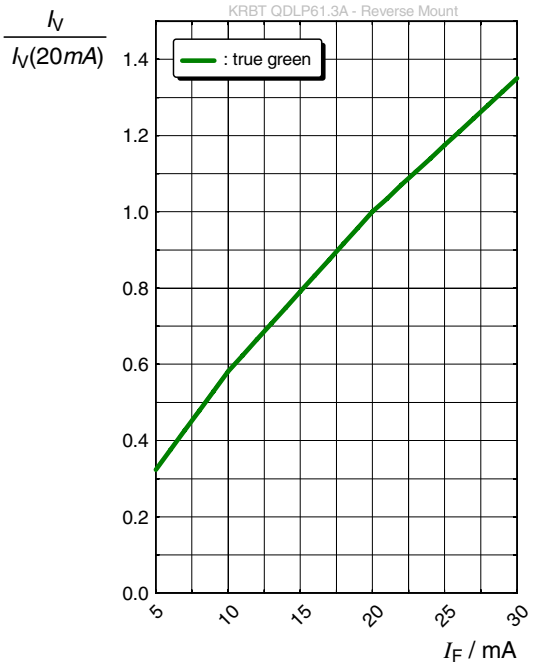
Relative Luminous Intensity 6), 7)

$I_v/I_v(\ ) = f(I_F)$; $T_S = 25\ °C$



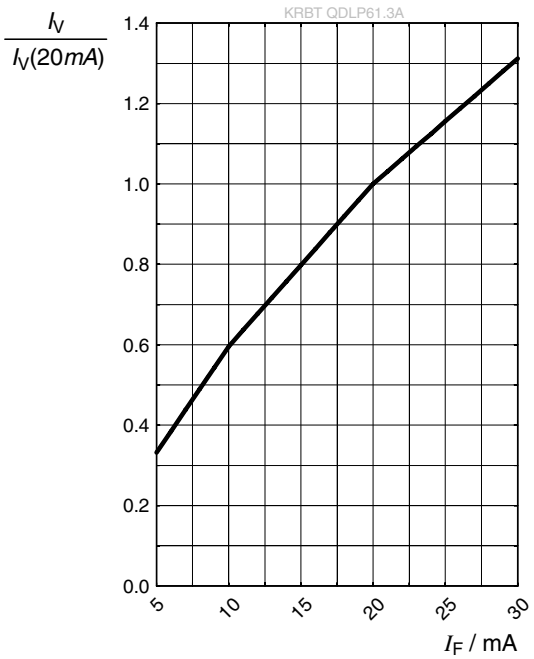
Relative Luminous Intensity 6), 7)

$I_v/I_v(\ ) = f(I_F)$; $T_S = 25\ °C$



Relative Luminous Intensity 6), 7)

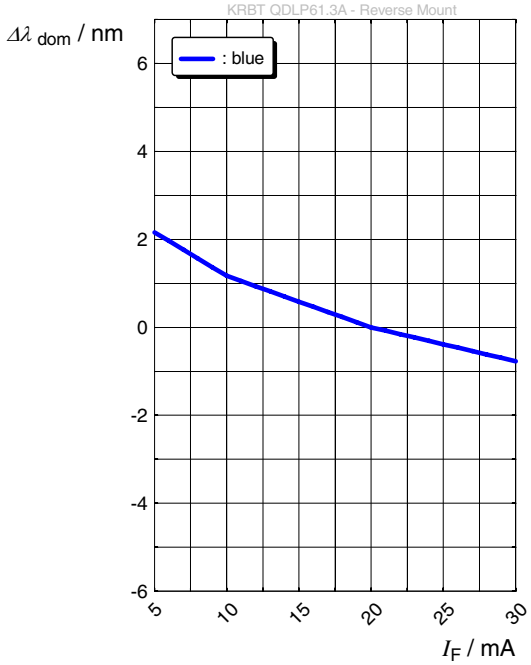
$I_v/I_v(\ ) = f(I_F)$; $T_S = 25\ °C$



Discontinued

Dominant Wavelength 6)

$\Delta\lambda_{dom} = f(I_F)$; T_S = 25 °C



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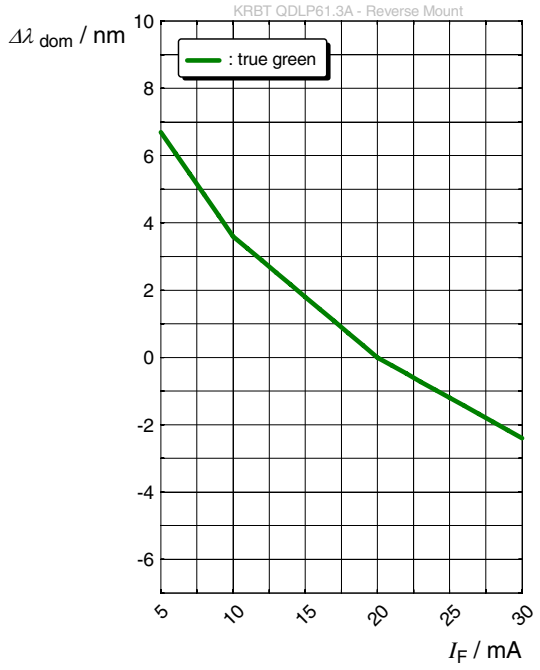
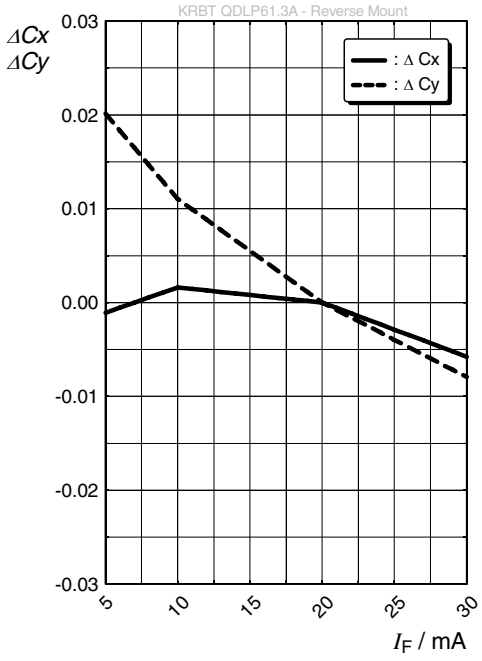


Chromaticity Coordinate Shift 6)

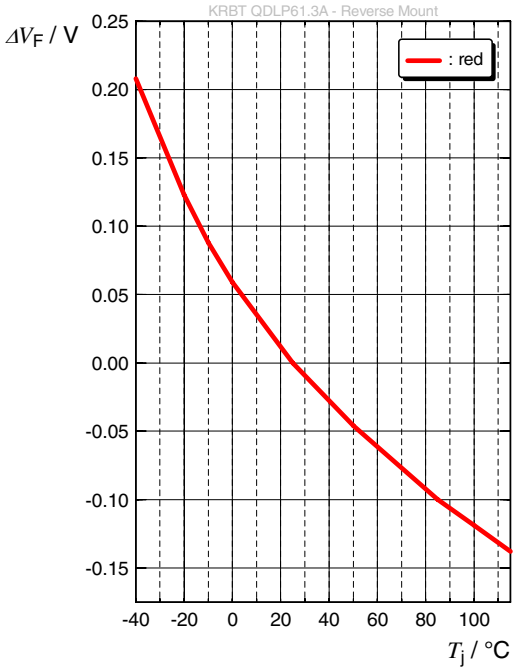
$\Delta Cx, \Delta Cy = f(I_F)$; T_S = 25 °C



Discontinued

Forward Voltage [6)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j)$; I_F = 20 mA



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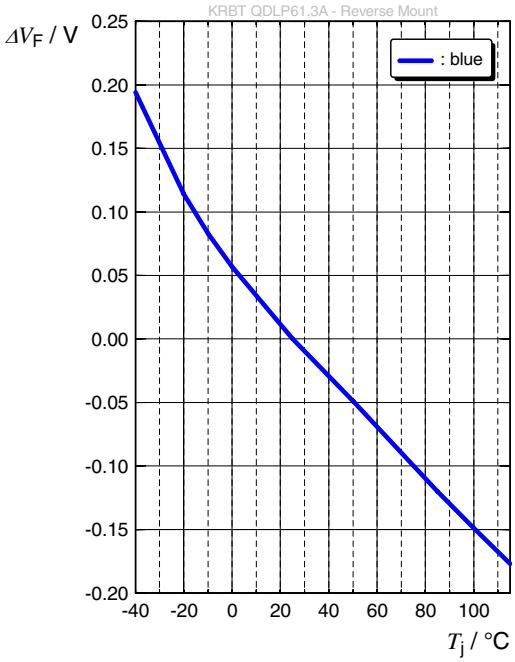

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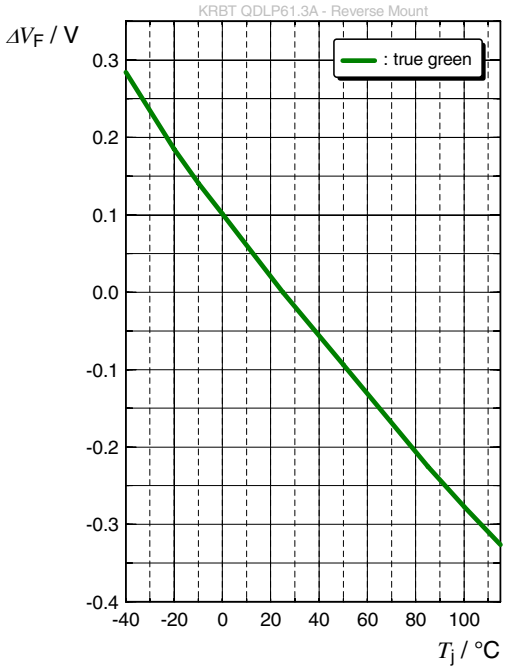
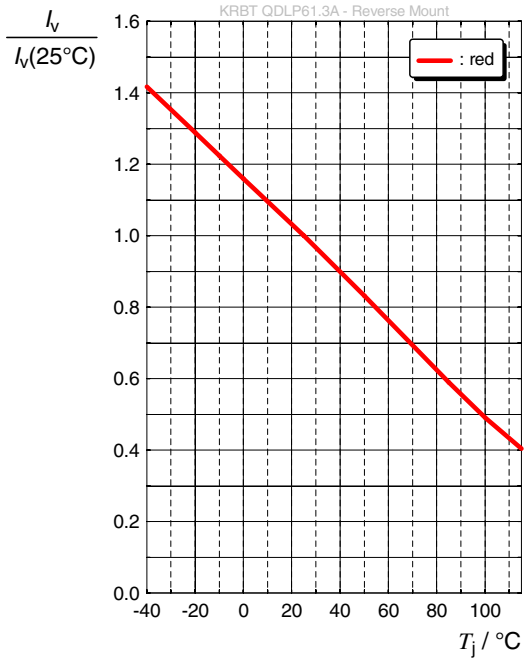


Relative Luminous Intensity 6)

$I_v/I_v(25\ °C) = f(T_j)$; I_F = 20 mA



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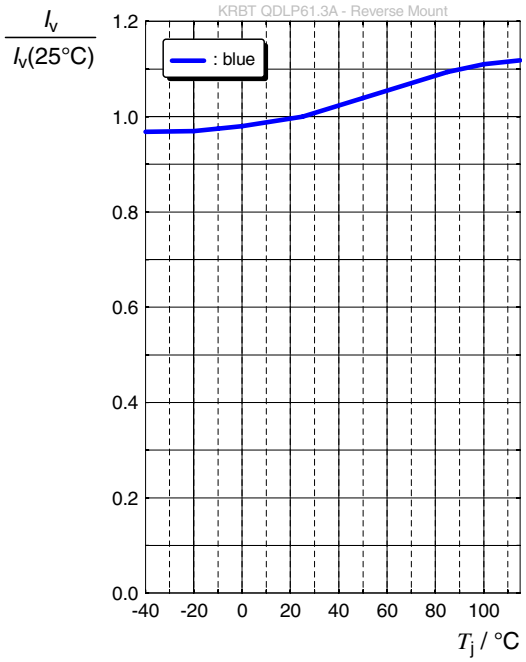

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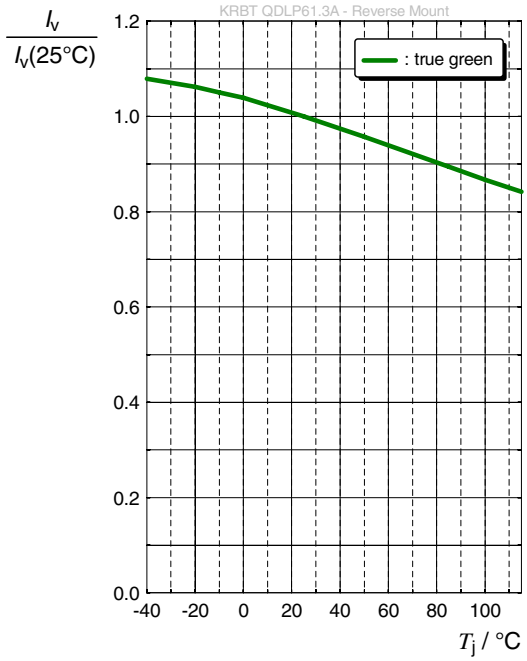

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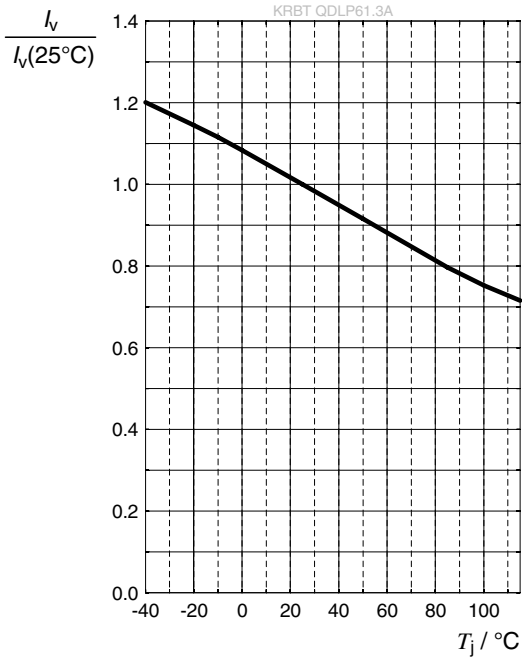
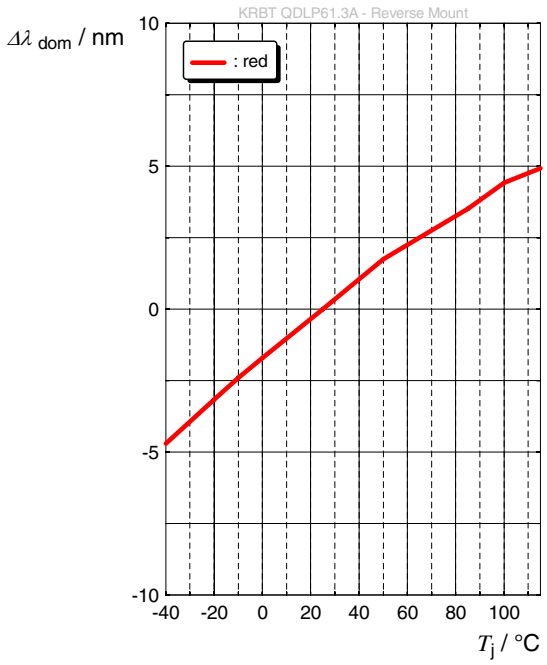


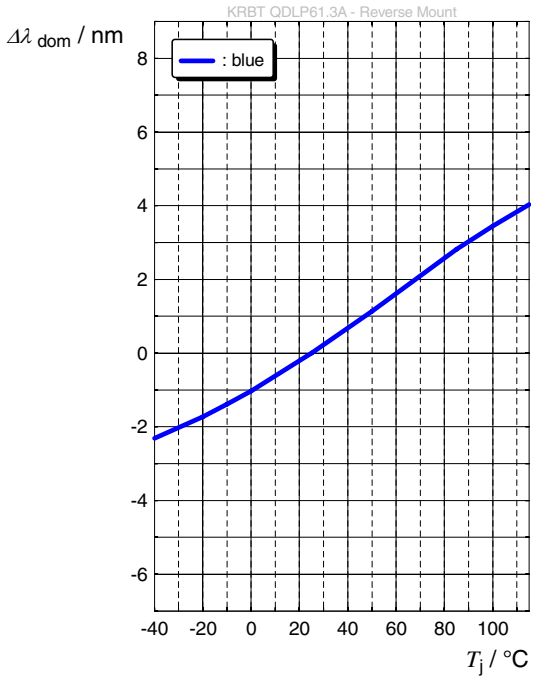
Dominant Wavelength [6]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j)$; $I_F = 20$ mA



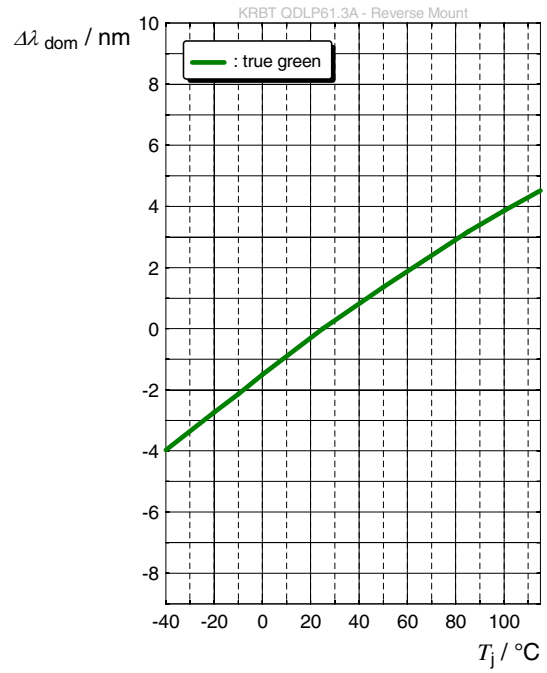
Dominant Wavelength [6]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j)$;



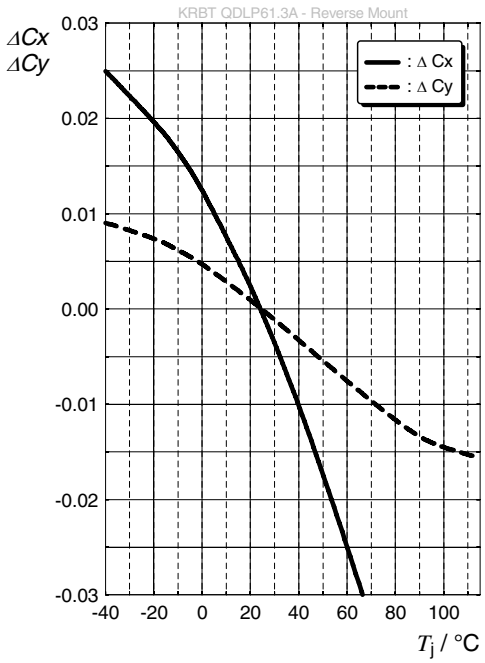
Dominant Wavelength [6]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j)$;



Chromaticity Coordinate Shift [6]

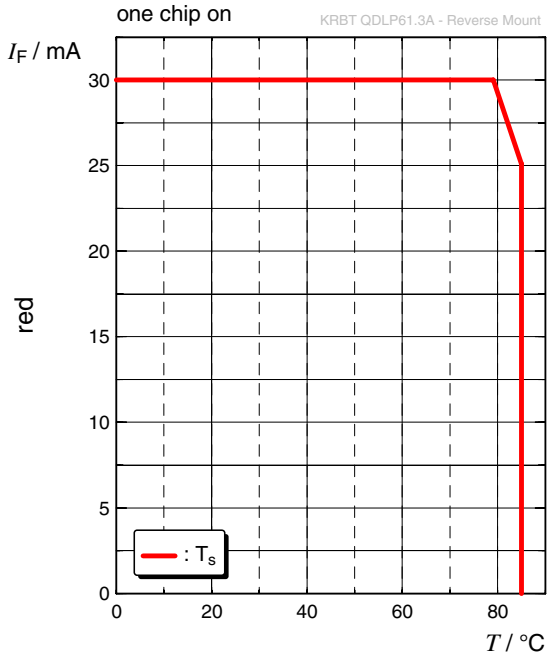
ΔCx, $\Delta Cy = f(T_j)$;



Discontinued

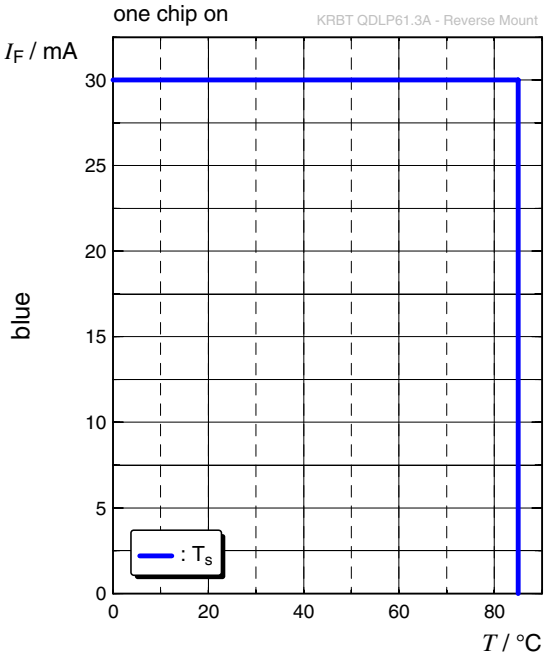
Max. Permissible Forward Current 4)

I_F = f(T); ● red



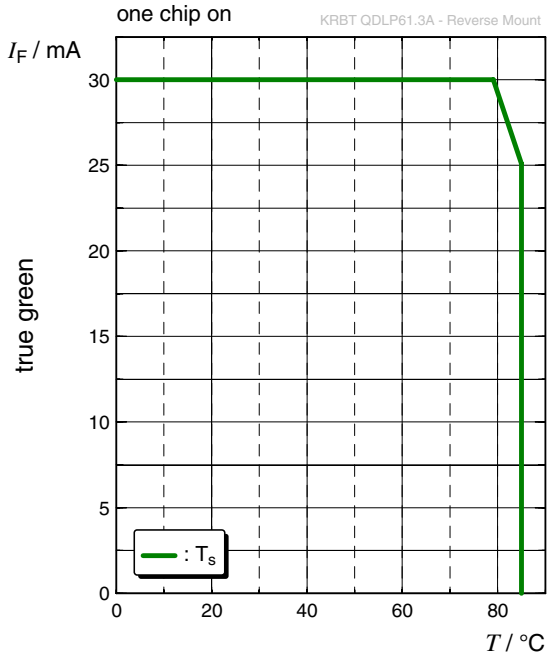
Max. Permissible Forward Current 4)

I_F = f(T); ● blue



Max. Permissible Forward Current 4)

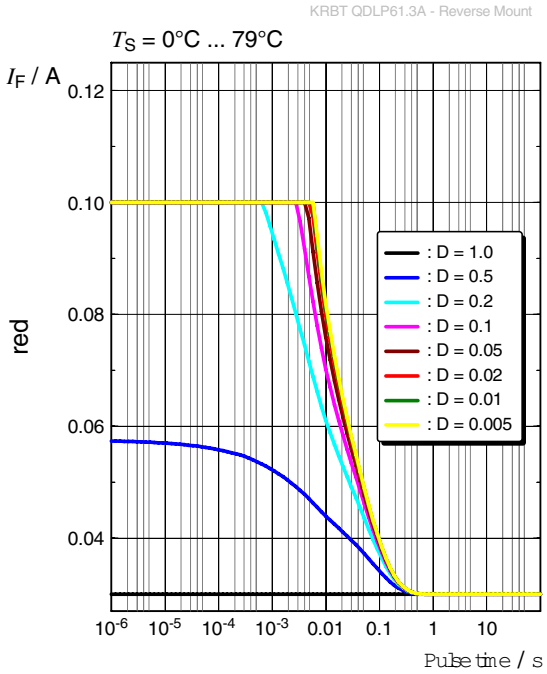
I_F = f(T); ● true green



Discontinued

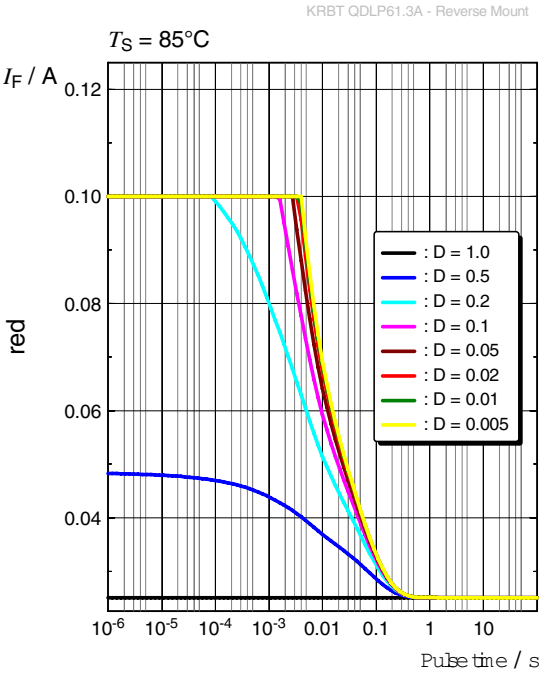
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; ● red



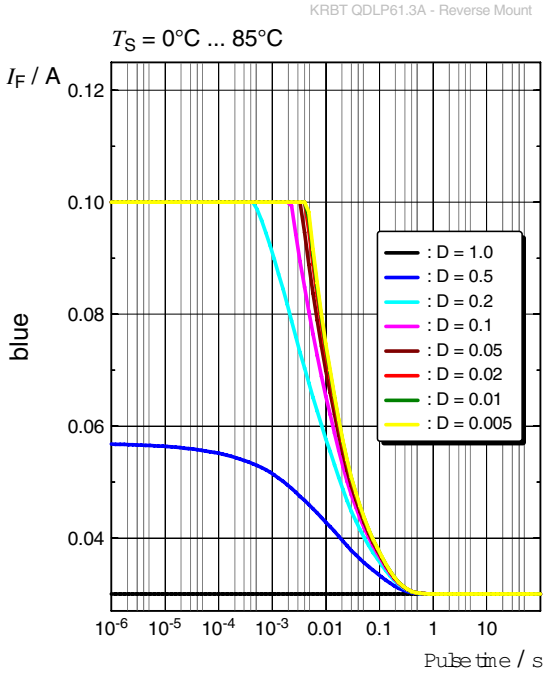
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; ● red



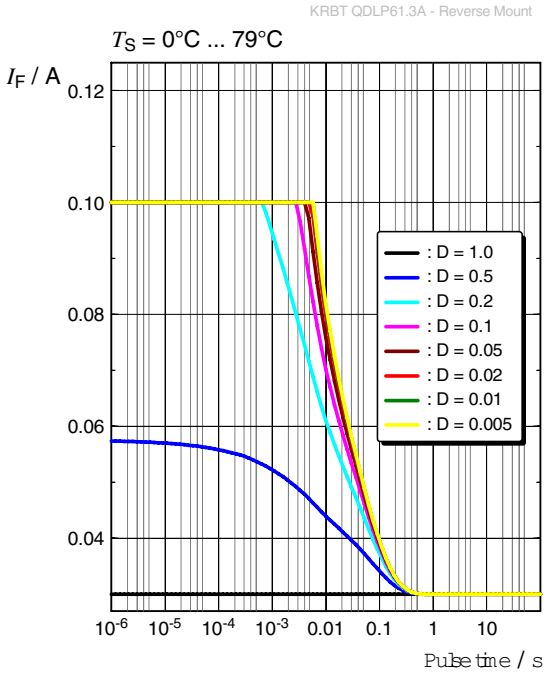
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; ● blue



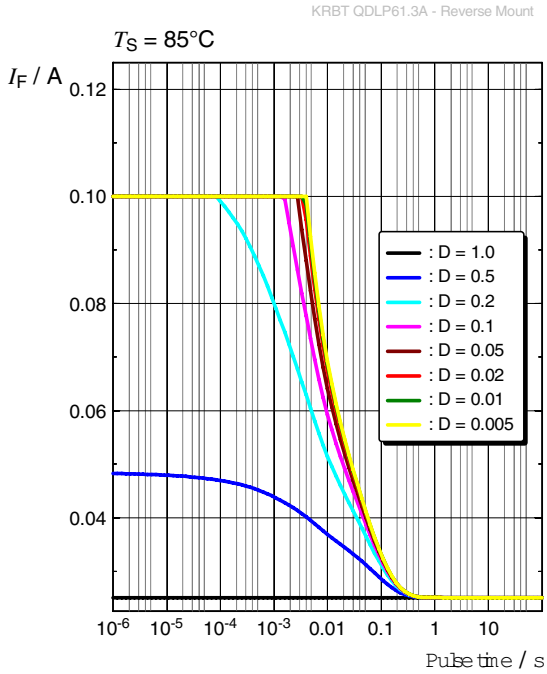
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; • true green

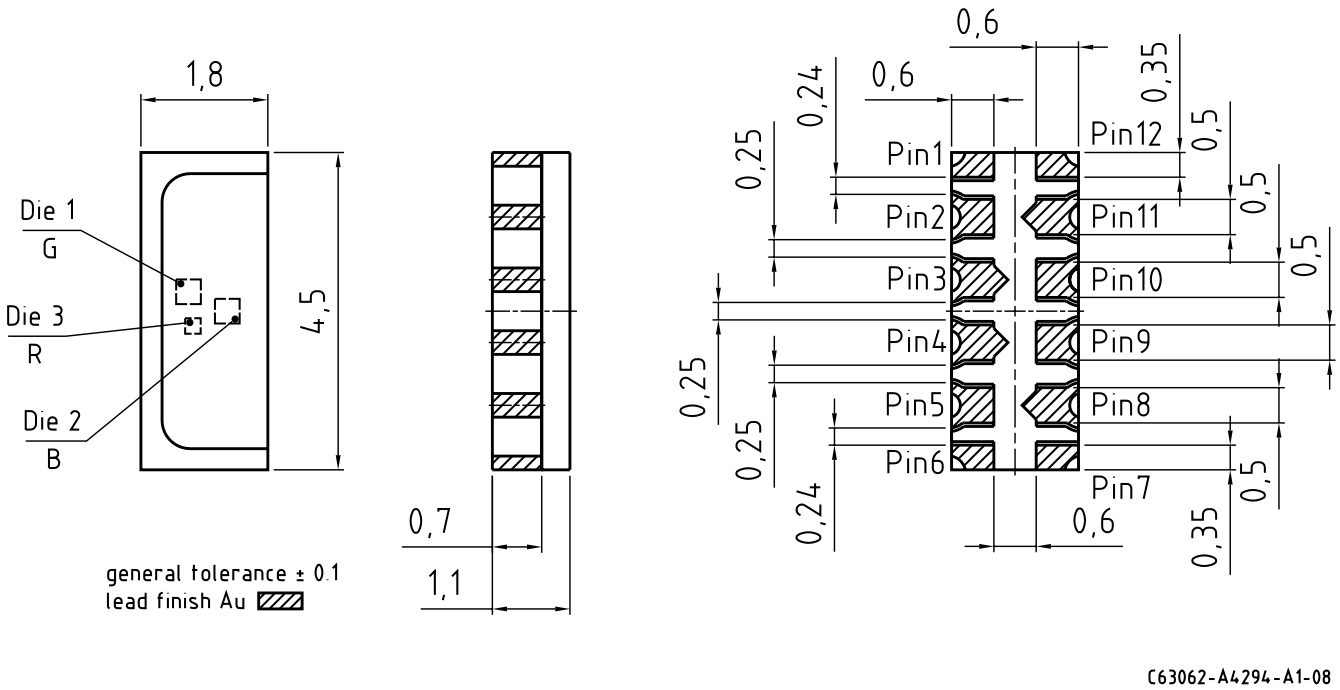


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; • true green



Dimensional Drawing [8)]



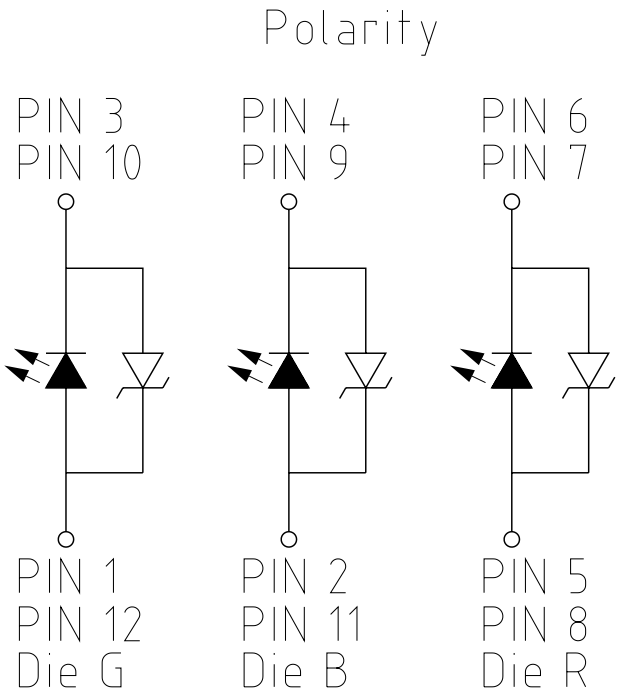
Further Information:

Approximate Weight: 8.9 mg

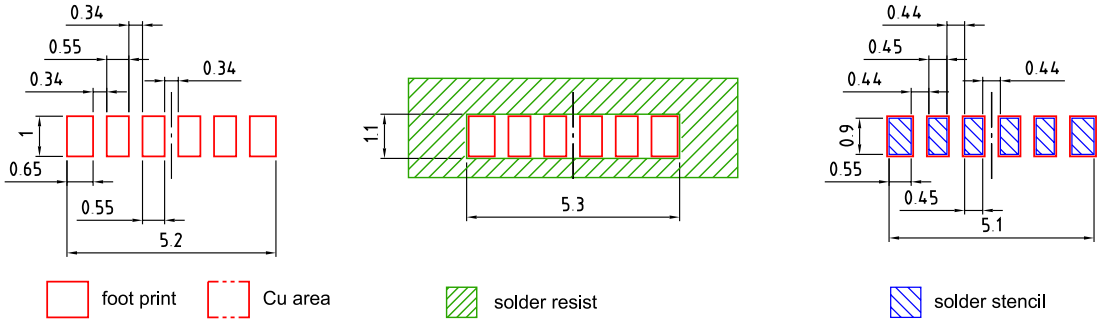
Corrosion test: Class: 1B
Test condition: 25°C / 75 % RH / 200ppb SO_2, 200ppb NO_2, 10ppb H_2S, 10ppb Cl_2 / 21 days (EN 60068-2-60 (Method 4))

Discontinued

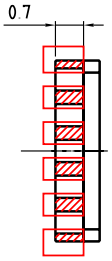
Electrical Internal Circuit



Recommended Solder Pad [8)]



Component Location on Pad

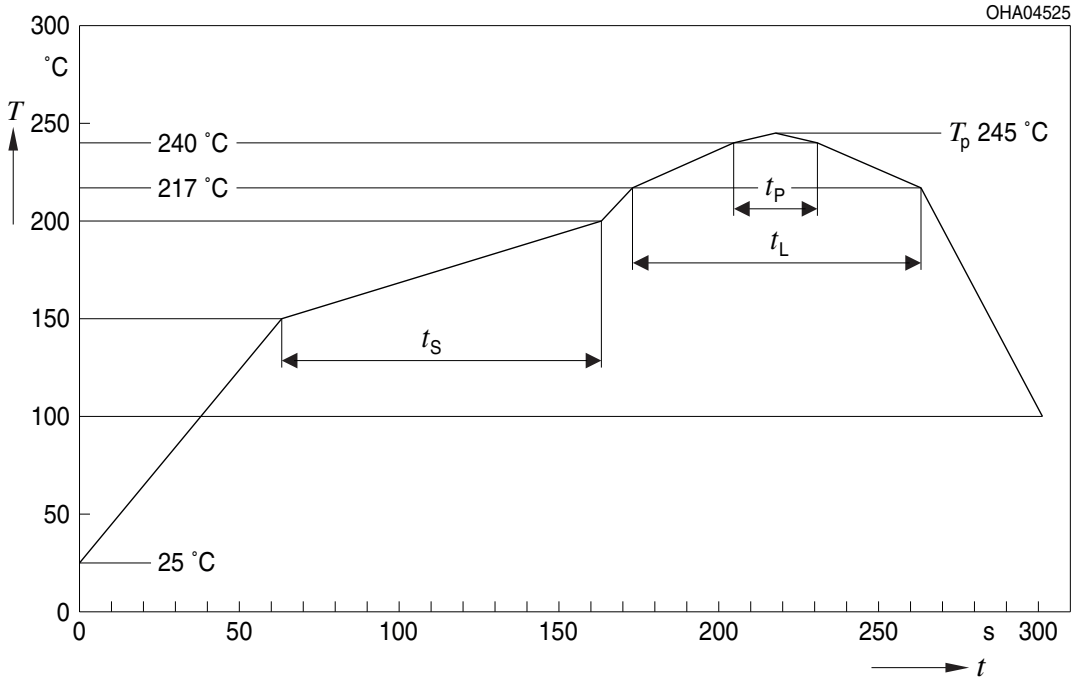


E062.3010.213 -02

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning. Handling Indication: The package is casted with silicone. Mechanical stress at the silicone surface of the unit should be avoided. Pickup the device at the plastic frame.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

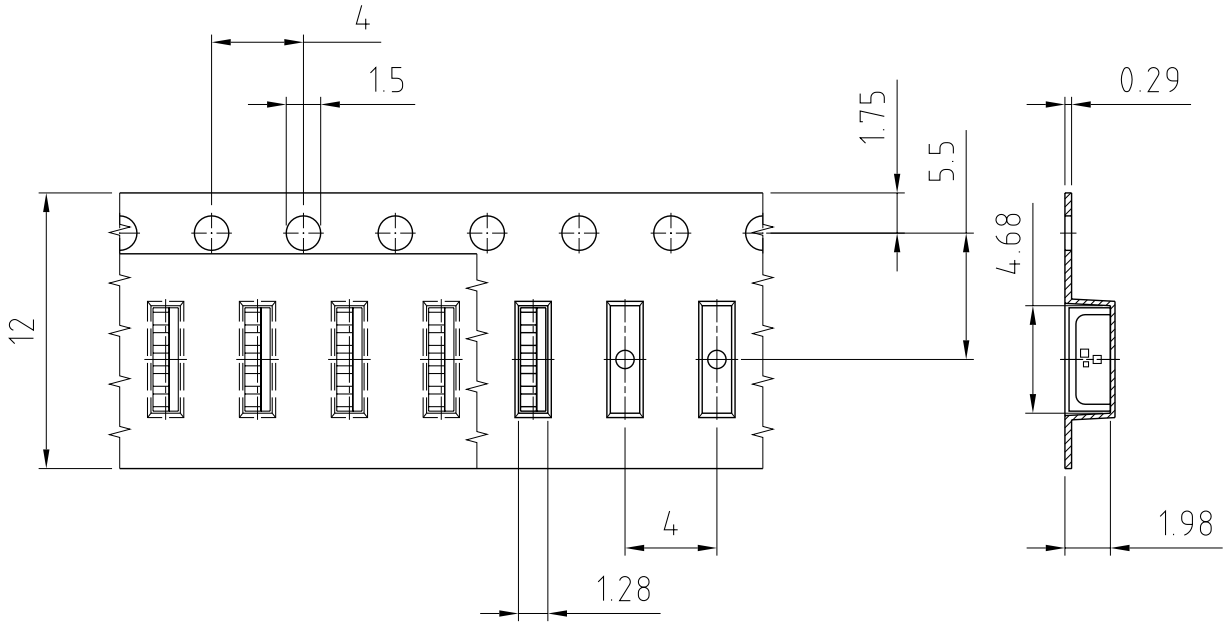


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

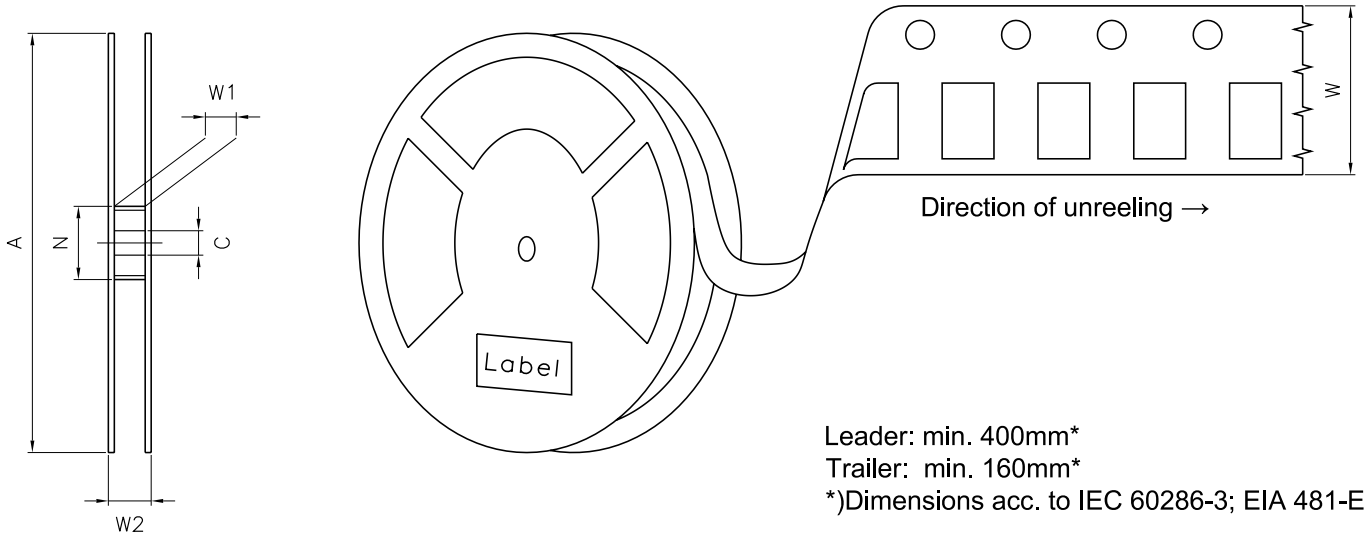
All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Discontinued

Taping [8)]



Tape and Reel [9)]



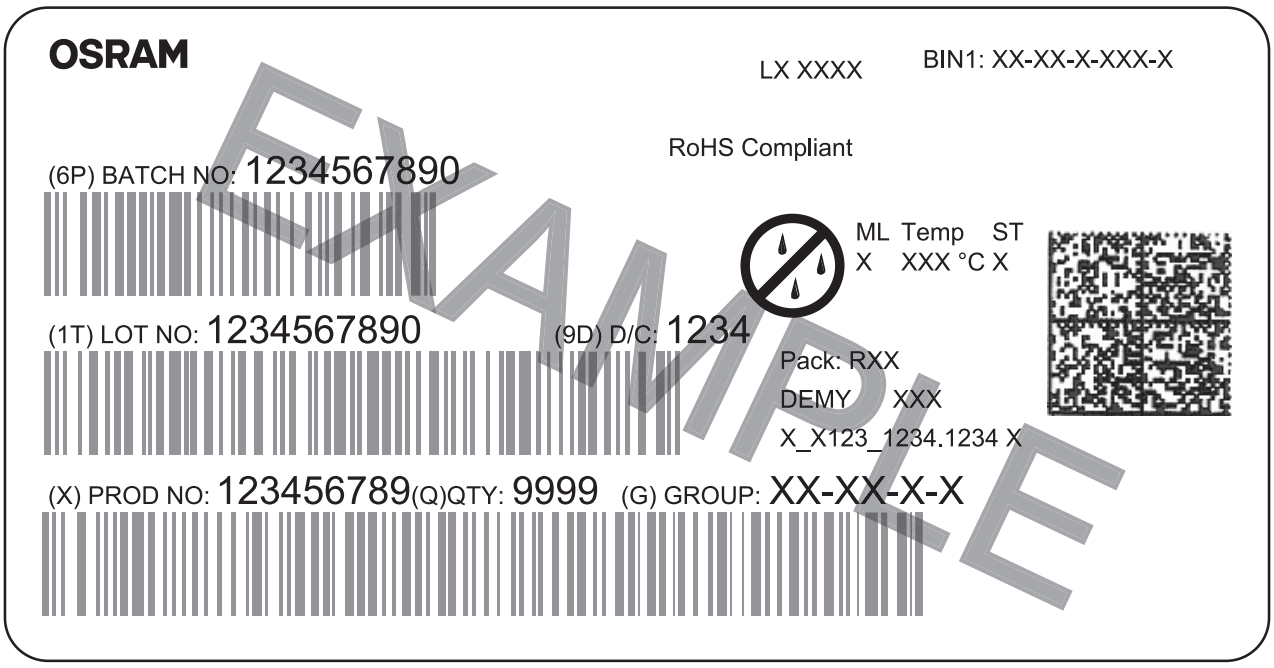
Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000

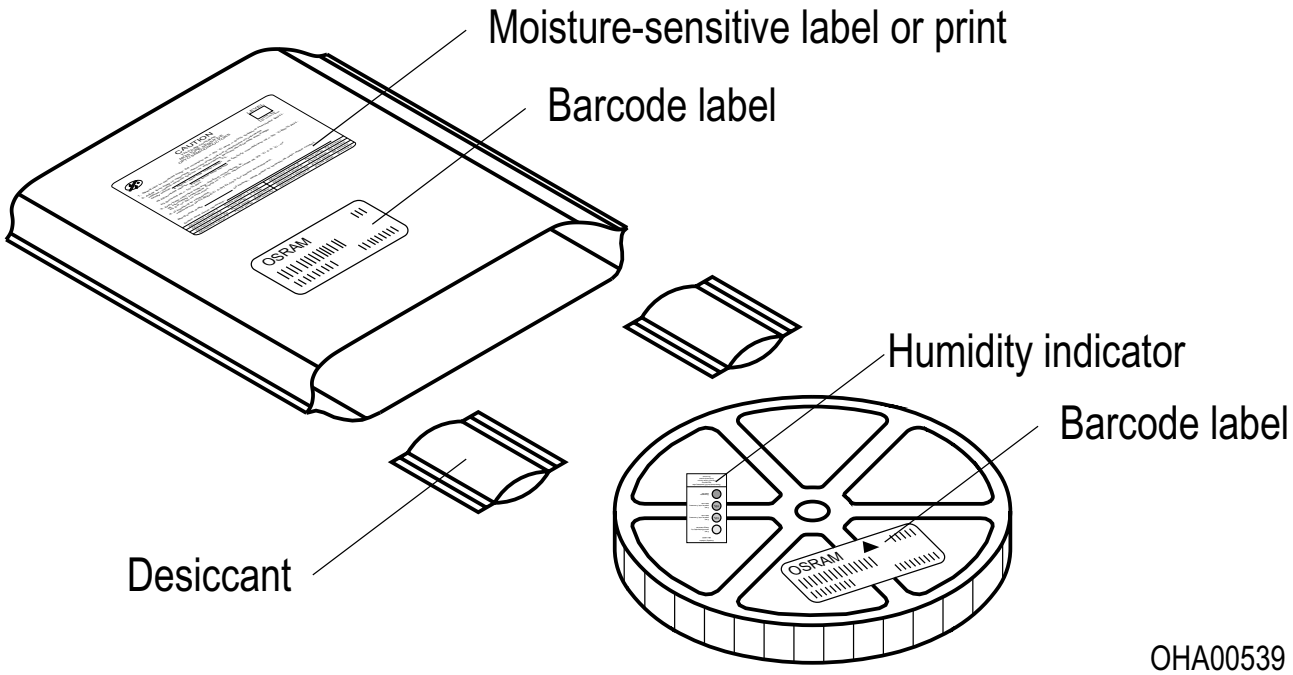
Discontinued

Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials [8)]

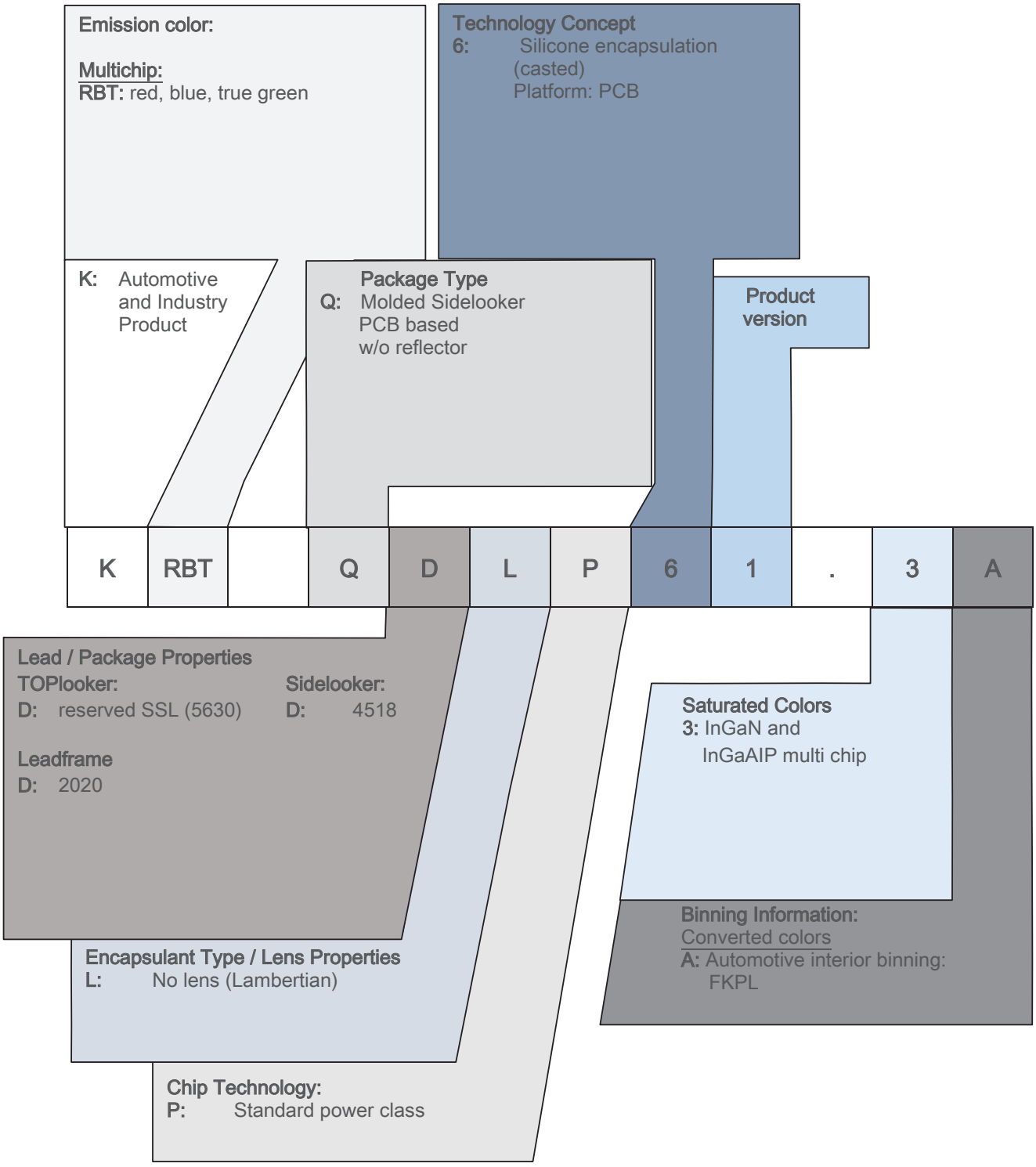


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Discontinued

Type Designation System



Discontinued

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.

2) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ±1 nm.

3) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ±0.1 V.

4) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

5) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.4	2018-11-28	Chromaticity Coordinate Groups
1.5	2024-11-20	New Layout Applications
1.6	2026-06-03	Discontinued

Discontinued

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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